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(54) **ORGANIC LIGHT-EMITTING DISPLAY
DEVICE AND MANUFACTURING METHOD
THEREOF**

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CPC **H01L 51/5259** (2013.01); **H01L 51/5246**
(2013.01)

(58) **Field of Classification Search**

None

See application file for complete search history.

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(57) **ABSTRACT**

An organic light-emitting display device includes a first substrate; a display unit on the first substrate; an encapsulation layer covering the display unit; a second substrate on the first substrate, wherein the display unit is interposed therebetween; a sealant between the encapsulation layer and the second substrate and at the outside of the display unit, wherein the sealant bonds the encapsulation layer and the second substrate to seal them; and a getter on the encapsulation layer in a region between the sealant and the display unit.

12 Claims, 5 Drawing Sheets

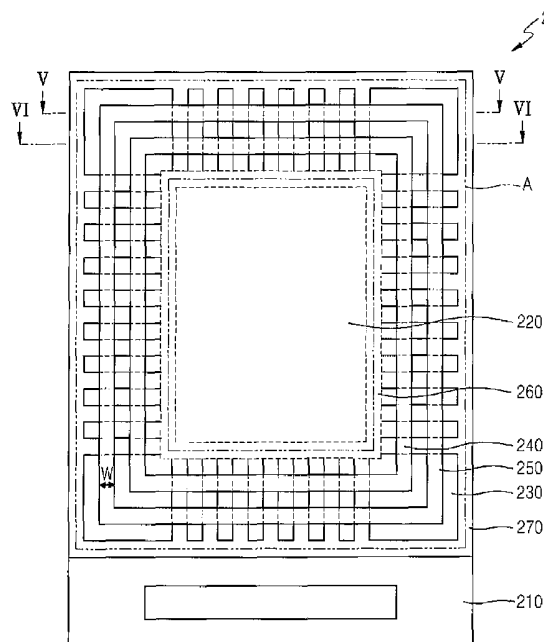


FIG. 1

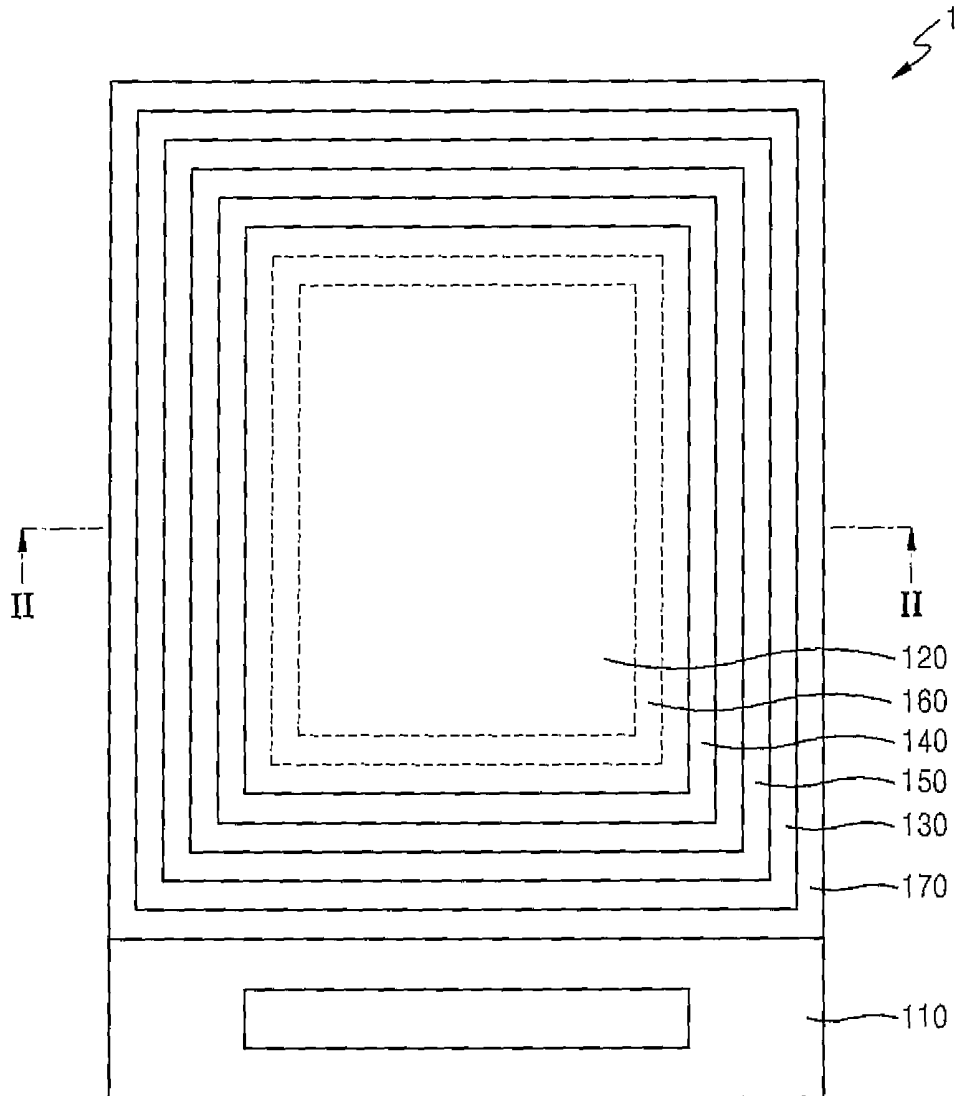


FIG. 2

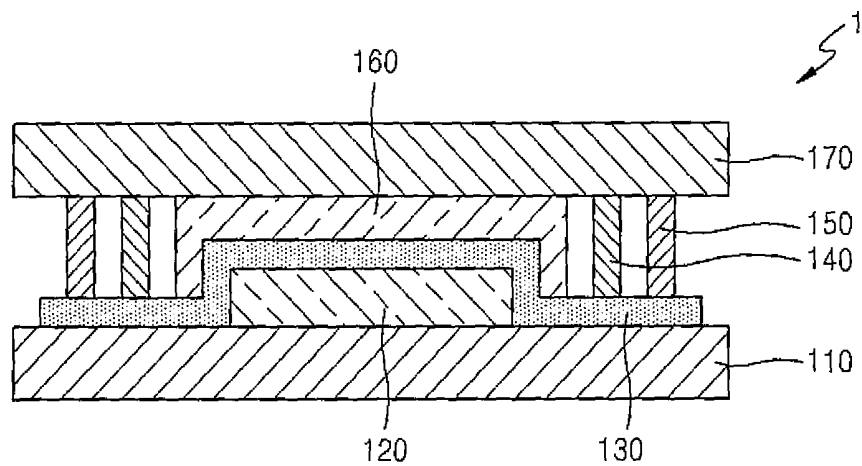


FIG. 3

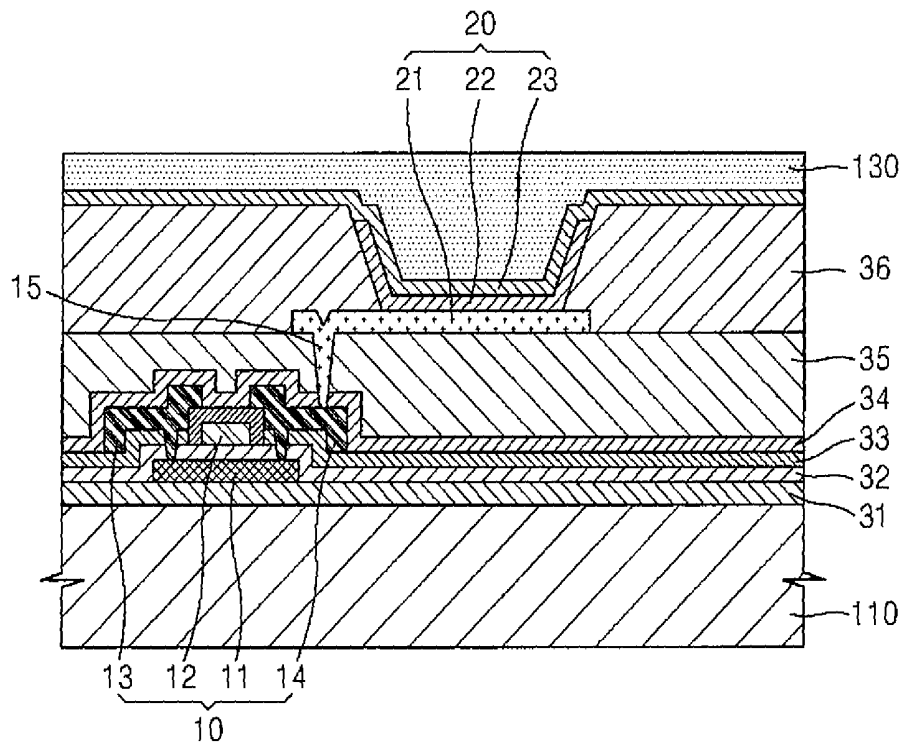


FIG. 4

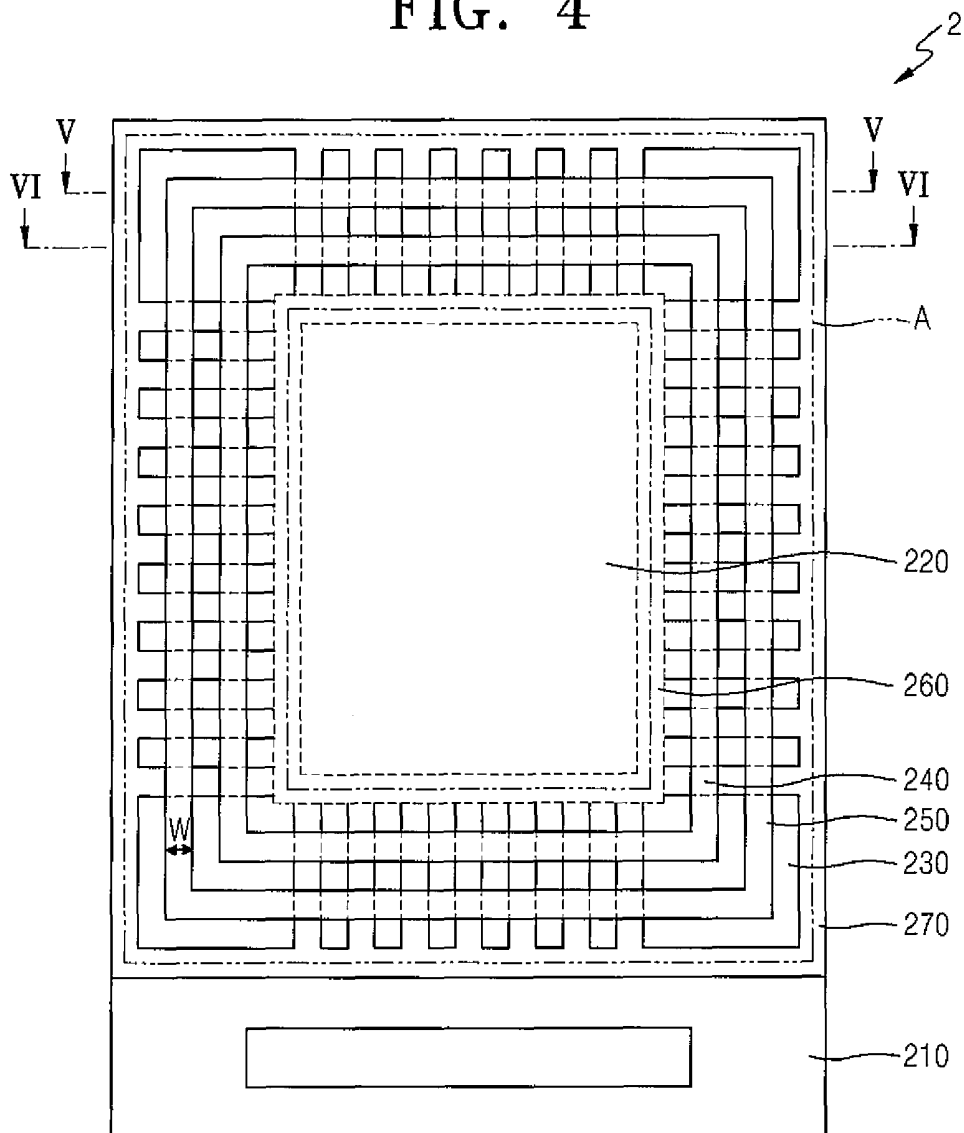


FIG. 5

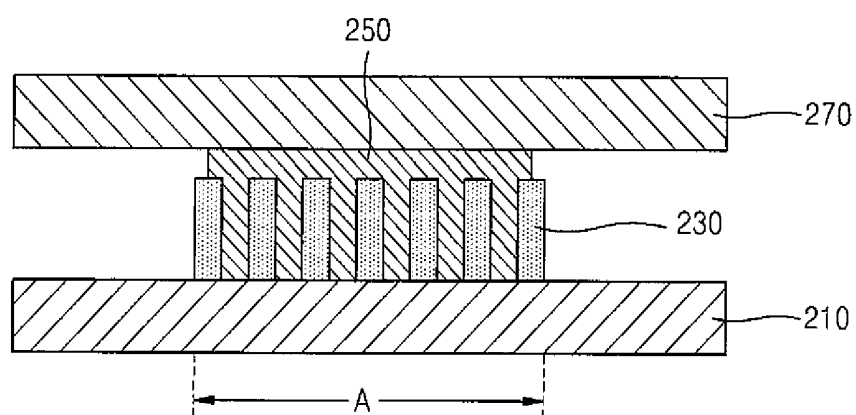


FIG. 6

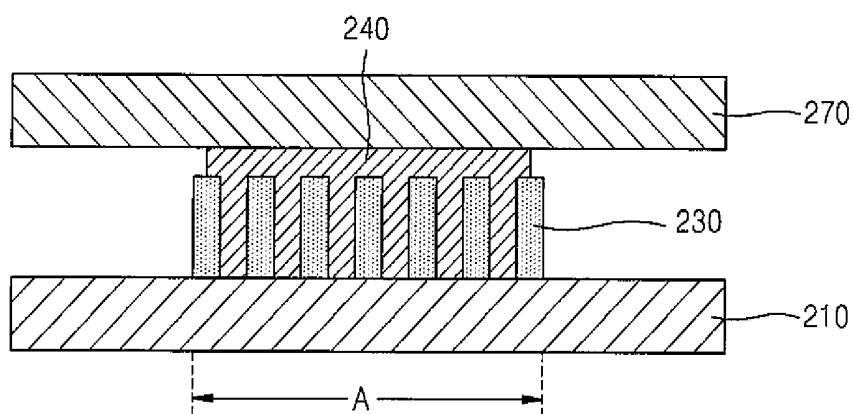


FIG. 7

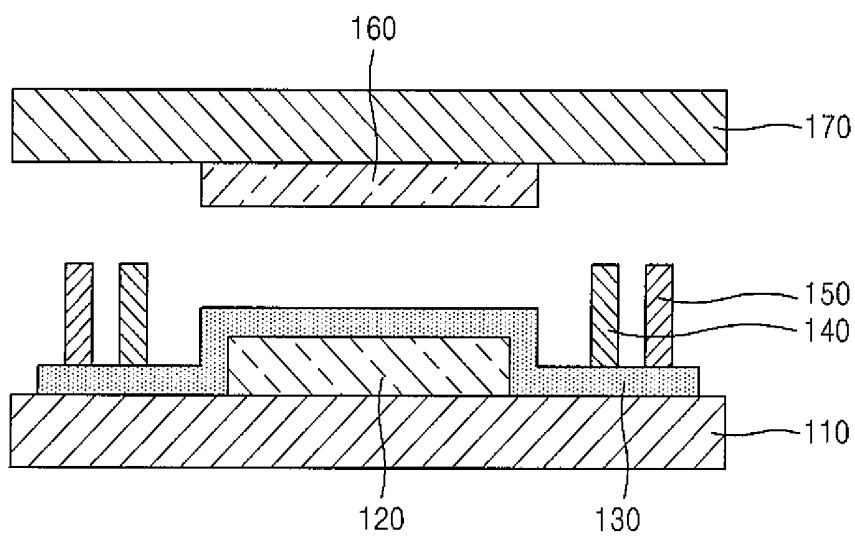
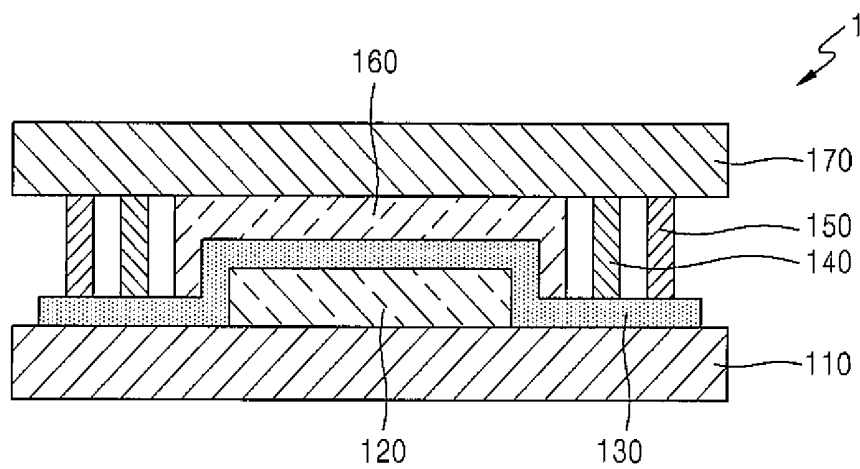


FIG. 8



ORGANIC LIGHT-EMITTING DISPLAY DEVICE AND MANUFACTURING METHOD THEREOF

CROSS-REFERENCE TO RELATED PATENT APPLICATION

This application claims priority to and the benefit of Korean Patent Application No. 10-2013-0023571, filed on Mar. 5, 2013, in the Korean Intellectual Property Office, the disclosure of which is incorporated herein in its entirety by reference.

BACKGROUND

1. Field

Embodiments of the present invention relate to an organic light-emitting display device and a method of manufacturing the same.

2. Description of the Related Art

Display devices are devices that display an image, and organic light-emitting display devices have recently drawn attention.

Organic light-emitting display devices emit light themselves and do not require a separate light source, unlike liquid crystal display devices, and thus the thickness and weight thereof may be reduced. In addition, organic light-emitting display devices have high quality characteristics such as low power consumption, high brightness, and high response speed.

In order to increase (or improve) the performance and lifespan of the organic light-emitting display device, the organic light-emitting display device may be tightly sealed to decrease (or minimize) the effect (or influence) of moisture and gas that may permeate (or enter) the organic light emitting display device from the outside. However, there may be a problem in that electrodes and an organic layer included in the above-described general organic light-emitting display device, and in particular, in an organic light-emitting element, are affected by oxygen and moisture that permeate (or enter) into the organic light-emitting display device. Consequently, the electrodes and the organic layer may deteriorate.

SUMMARY

Aspects of embodiments of the present invention are directed toward an organic light-emitting display device that effectively blocks external substances, and a method of manufacturing the organic light-emitting display device.

According to an embodiment of the present invention, there is provided an organic light-emitting display device including: a first substrate; a display unit on the first substrate; an encapsulation layer covering the display unit; a second substrate on the first substrate, wherein the display unit is interposed therebetween; a sealant between the encapsulation layer and the second substrate and at the outside of the display unit, wherein the sealant bonds the encapsulation layer and the second substrate to seal them; and a getter on the encapsulation layer in a region between the sealant and the display unit.

The organic light-emitting display device may further include a filler between the encapsulation layer and the second substrate.

The encapsulation layer may include at least one selected from the group consisting of SiNx, SiOx, SiOC, and SiC and combinations thereof.

The sealant may include a photo-curing material.

The getter may be cured from a liquid phase to a solid phase.

The encapsulation layer may include an inorganic layer.

The second substrate may be an opaque substrate, and the display unit may be configured to emit light toward the first substrate.

According to another aspect of the present invention, there is provided an organic light-emitting display device comprising: a first substrate; a display unit on the first substrate; an encapsulation layer covering the display unit and having a concavo-convex region at the outside of the display unit; a second substrate on the first substrate, wherein the display unit is interposed therebetween; a sealant between the first substrate and the second substrate, wherein the sealant bonds the first substrate and the second substrate together to seal them; and a getter between the sealant and the display unit at the concavo-convex region.

The organic light-emitting display device may further include a filler between the encapsulation layer and the second substrate.

The encapsulation layer may include at least one selected from the group consisting of SiNx, SiOx, SiOC, SiC and combinations thereof.

The sealant may include a photo-curing material.

The getter may be cured from a liquid phase to a solid phase.

The encapsulation layer may include an inorganic layer.

The second substrate may be an opaque substrate, and the display unit may be configured to emit light toward the first substrate.

According to another embodiment of the present invention, there is provided a method of manufacturing an organic light-emitting display device, the method including: forming an encapsulation layer on a first substrate at which a display unit is located, so as to cover the display unit; forming a sealant on the encapsulation layer at the outside of the display unit; forming a liquid getter in a region between the sealant and the display unit; and bonding the encapsulation layer and the second substrate together to seal them, wherein the display unit is interposed therebetween.

The bonding of the encapsulation layer and the second substrate together may include forming a filler on the second substrate.

The bonding of the encapsulation layer and the second substrate together may include: disposing the second substrate on the encapsulation layer with the liquid getter and the filler interposed therebetween; and curing the sealant by irradiating it with light.

The bonding of the encapsulation layer and the second substrate together may further include applying heat to the liquid getter to change its phase from liquid to solid.

The solid getter and the filler may be separated from each other.

In the forming of the encapsulation layer on the first substrate, the encapsulation layer may have a concavo-convex region at the outside of the display unit.

BRIEF DESCRIPTION OF THE DRAWINGS

The above and other features and aspects of the present invention will become more apparent by describing in detail embodiments thereof with reference to the attached drawings in which:

FIG. 1 is a schematic plan view illustrating an organic light-emitting display device according to an embodiment of the present invention;

FIG. 2 is a schematic cross-sectional view taken along the line II-II shown in FIG. 1;

FIG. 3 is a schematic cross-sectional view illustrating a portion of the organic light-emitting display device shown in FIG. 1;

FIG. 4 is a schematic plan view illustrating an organic light-emitting display device according to another embodiment of the present invention;

FIG. 5 is a schematic cross-sectional view taken along the line V-V shown in FIG. 4;

FIG. 6 is a schematic cross-sectional view taken along the line VI-VI shown in FIG. 4; and

FIGS. 7 and 8 are cross-sectional views illustrating a method of manufacturing the organic light-emitting display device according to the embodiment of the present invention shown in FIG. 1.

DETAILED DESCRIPTION

Hereinafter, one or more embodiments of the present invention will be described in detail with reference to the accompanying drawings. As used herein, the term “and/or” includes any and all combinations of one or more of the associated listed items.

FIG. 1 is a schematic plan view illustrating an organic light-emitting display device 1 according to an embodiment of the present invention. FIG. 2 is a schematic cross-sectional view taken along the line II-II shown in FIG. 1.

Referring to FIGS. 1 and 2, the organic light-emitting display device 1 according to the current embodiment of the present invention may include a first substrate 110, a display unit 120, an encapsulation layer 130, a getter 140, a sealant 150, a filler 160, and a second substrate 170.

The first substrate 110 and the second substrate 170 are substrates that may include glass, a polymer, a metal, or the like, and at least one of the first substrate 110 and/or the second substrate 170 may be formed of a light transmitting material. The first substrate 110 may be formed of a light transmitting material, and the second substrate 170 may be formed of a non-light transmitting material. In other words, the second substrate 170 may be an opaque substrate containing aluminum (Al) or copper (Cu). The display unit 120 is located on the first substrate 110, and the second substrate 170 faces the first substrate 110 with the display unit 120 and the encapsulation layer 130 interposed therebetween. The second substrate 170 and the encapsulation layer 130 are bonded to each other using the sealant 150 and are sealed. The first substrate 110 and the second substrate 170 protect the display unit 120 from external interference.

The display unit 120 is formed on the first substrate 110 and displays an image.

The encapsulation layer 130 is formed so as to cover the display unit 120 and serves to protect the display unit 120.

Hereinafter, the display unit 120 and the encapsulation layer 130 of the organic light-emitting display device 1 according to the current embodiment of the present invention will be described in detail with reference to FIG. 3.

FIG. 3 is a schematic cross-sectional view illustrating a portion of the organic light-emitting display device 1 shown in FIG. 1.

Referring to FIG. 3, the organic light-emitting display device 1 according to the current embodiment includes the first substrate 110, an organic light-emitting element 20, and the encapsulation layer 130. The display unit 120 includes the organic light-emitting element 20.

A thin film transistor (TFT) 10 coupled to the organic light-emitting element 20 and the organic light-emitting ele-

ment 20 is disposed (or located) on the first substrate 110. Although one organic light-emitting element 20 and one TFT 10 are illustrated in FIG. 3, this is just for convenience of description, and a portion of the light-emitting display device according to the current embodiment may include a plurality of the organic light-emitting elements 20 and a plurality of the TFTs 10.

The organic light-emitting display device may be classified into a passive matrix (PM) organic light-emitting display device and an active matrix (AM) organic light-emitting display device depending on whether the driving of each organic light-emitting element 20 is controlled by the TFT 10. The organic light-emitting display device according to the current embodiment may be applied to either the AM organic light-emitting display device or the PM organic light-emitting display device. Hereinafter, the current embodiment of the present invention will be described in detail by using the AM organic light-emitting display device as an example.

A buffer layer 31 that may be formed of silicon dioxide (SiO₂) and/or SiN_x may further be disposed (or located) on the first substrate 110 in order to planarize the first substrate 110 and to reduce (or prevent) the permeation (e.g., the penetration or entrance) of impurities.

An active layer 11 of the TFT 10, which is formed of a semiconductor material according to one embodiment, is formed on the buffer layer 31. The active layer 11 may be formed of polycrystalline silicon, but embodiments of the present invention are not limited thereto, and the active layer 11 may be formed of an oxide semiconductor. For example, the oxide semiconductor may contain any one of Groups 12, 13, and 14 metallic elements including, for example, metal zinc (Zn), indium (In), gallium (Ga), tin (Sn), cadmium (Cd), germanium (Ge), or hafnium (Hf), or an oxide of a material selected from combinations thereof. For example, the active layer 11 may include G-I—O[(In₂O₃a)(Ga₂O₃b)(ZnO)c] (a, b, and c are real numbers satisfying conditions a≥0, b≥0, and c>0, respectively).

A gate insulating layer 32 is formed so as to cover the active layer 11. A gate electrode 12 is disposed (or located) on the gate insulating layer 32, and an insulating interlayer 33 is formed so as to cover the gate electrode 12. A source electrode 13 and a drain electrode 14 are disposed (or located) on the insulating interlayer 33, and a passivation layer 34 and a planarization layer 35 are sequentially disposed (or located) so as to cover the source electrode 13 and the drain electrode 14.

The gate insulating layer 32, the insulating interlayer 33, the passivation layer 34, and the planarization layer 35 may be formed of an insulating material, and may be formed to have a single-layered structure or a multiple-layered structure including an inorganic material, an organic material, or an organic/inorganic composite material. The above-described layered structure of the TFT 10 is just an example, and embodiments of the present invention may be applied to a TFT having any of various other suitable structures.

A first electrode 21 serving as an anode of the organic light-emitting element 20 is formed on the above-mentioned planarization layer 35, and a pixel definition layer 36, which is formed of an insulating material, is formed so as to cover the first electrode 21. After an opening (e.g., a predetermined opening) is formed in the pixel definition layer 36, an organic emission layer 22 of the organic light-emitting element 20 is formed in a region defined by the opening. Then, a second electrode 23 serving as a cathode of the organic light-emitting element 20 is formed so as to cover all pixels. In other embodiments, the polarities of the first electrode 21 and the second electrode 23 may be reversed.

The first electrode **21** may be a transparent electrode or a reflective electrode. When the first electrode **21** is a transparent electrode, the first electrode **21** may be formed of indium tin oxide (ITO), indium zinc oxide (IZO), zinc oxide (ZnO), or indium (III) oxide (In₂O₃), and when the first electrode **21** is a reflective electrode, the first electrode **21** may have a structure in which a reflective layer formed of ITO, IZO, ZnO, or In₂O₃ is stacked on a reflective layer formed of silver (Ag), magnesium (Mg), aluminum (Al), platinum (Pt), palladium (Pd), gold (Au), nickel (Ni), neodymium (Nd), iridium (Ir), chromium (Cr), or a compound thereof. Although the second electrode **23** may be a transparent electrode or a reflective electrode, when the second electrode **23** is a transparent electrode, the second electrode **23** may have a structure in which an auxiliary electrode or a bus electrode line formed of a material for forming a transparent electrode, for example, ITO, IZO, ZnO, or In₂O₃, is stacked on a layer coated with lithium (Li), calcium (Ca), lithium fluoride/calcium (LiF/Ca), lithium fluoride/aluminum (LiF/Al), Al, Mg, or a compound thereof so as to face the organic emission layer **22**. When the second electrode **23** is a reflective electrode, the second electrode **23** may be formed by coating Li, Ca, LiF/Ca, LiF/Al, Al, Mg, or a compound thereof, thereon.

The organic emission layer **22** interposed between the first electrode **21** and the second electrode **23** may be formed of a low-molecular weight organic material or a polymer organic material. When the organic emission layer **22** is formed of a low-molecular weight organic material, a hole injection layer (HIL; not shown), a hole transport layer (HTL; not shown), an electron transport layer (ETL; not shown), an electron injection layer (EIL; not shown), and the like may be stacked around the organic emission layer **22** so as to have a single-layered structure or a multiple-layered structure. Examples of available organic materials may include copper phthalocyanine (CuPc), N,N'-di(naphthalene-1-yl)-N,N'-diphenyl-benzidine (NPB), tris-8-hydroxyquinoline aluminum (Alq₃), and the like. These low-molecular weight organic materials may be formed by vacuum deposition by using masks.

When the organic emission layer **22** is formed of a polymer organic material, the organic emission layer **22** may have a structure in which an HTL may further be formed toward the anode from the organic emission layer **22**. Here, according to one embodiment, Poly(3,4-Ethylene Di Oxy Thiophene) (PEDOT) is used as the HTL, and a polymer organic material (such as a poly-phenylenevinylene (PPV)-based polymer organic material or a polyfluorene-based polymer organic material) is used as an emission layer.

In the above-described embodiment, a case has been described where the organic emission layer **22** is formed within the opening and a separate light-emitting material is formed for each pixel, but embodiments of the present invention are not limited thereto. The organic emission layer **22** may be commonly formed on the entire pixel definition layer **36** regardless of the location of the pixel. For example, the organic emission layer **22** may be formed in such a manner so that layers including light-emitting materials that respectively emit red, green, and blue light are vertically stacked thereon or combined together. As long as the organic emission layer **22** may emit white light, the combination of different colors may be made. In addition, the organic light-emitting display device **1** may further include a color changing layer that changes the emitted white light into a color (e.g., a predetermined color), or a color filter.

Because there is a tendency for the organic light-emitting element **20** to deteriorate due to a material such as moisture or oxygen, the encapsulation layer **130** is disposed (or located),

as described above, so as to cover the display unit **120** at which the organic light-emitting element **20** is located.

The encapsulation layer **130** may be formed by alternately stacking at least one organic layer and at least one inorganic layer, or may be formed of only an inorganic layer. Furthermore, a plurality of the inorganic layers and/or a plurality of the organic layers may be formed.

In one embodiment, the organic layer is formed of a polymer, and in one embodiment, is a single layer or a stacked layer which is formed of any one of polyethylene terephthalate, polyimide, polycarbonate, epoxy, polyethylene, and polyacrylate. Moreover, the organic layer may be formed of polyacrylate, and specifically may include a material in which a monomer composition including a diacrylate-based monomer and a triacrylate-based monomer is polymerized. The organic layer may be formed of a material in which a monoacrylate-based monomer is added to the monomer composition. Alternatively, the organic layer may be formed of a material in which a suitable photoinitiator such as TPO is added to the monomer composition, but embodiments of the present invention are not limited thereto.

The inorganic layer may be a single layer or a stacked layer including a metal oxide or a metal nitride. Specifically, the inorganic layer may include at least one selected from the group consisting of SiN_x, Al(2)O(3), SiO(2), TiO(2), SiOC, SiC, and combinations thereof.

In the encapsulation layer **130**, the uppermost layer that is externally exposed may be formed of an inorganic layer in order to reduce (or prevent) moisture from permeating into the organic light-emitting element **20**.

Referring back to FIGS. 1 and 2, the sealant **150** is located between the encapsulation layer **130** and the second substrate **170**, surrounds the display unit **120** so as to be spaced apart from the display unit **120** at an interval (e.g., a predetermined interval), and is disposed (or located) along edges of the encapsulation layer **130** and the second substrate **170**, and thus the encapsulation layer **130** and the second substrate **170** are bonded to each other and sealed. The sealant **150** may include an organic material including epoxy, acrylic, silicon, or the like containing a photo-curing material, or an organic/inorganic composite material in which talc, calcium oxide (CaO), barium oxide (BaO), zeolite, SiO or the like is added to an organic material with the sealant **150** having been cured by light such as ultra violet (UV) rays.

A getter **140** is located between the display unit **120** and the sealant **150**. The getter **140** may be formed on the encapsulation layer **130**. The getter **140** is sealed by the sealant **150**, the filler **160**, the encapsulation layer **130** at a portion between the sealant **150** and the filler **160**, and the second substrate **170** at a portion between the sealant **150** and the filler **160**. The getter **140** has a moisture absorbing property, and functions to reduce (or prevent) moisture from permeating (or entering) into the display unit **120** through the sealant **150** from the outside. In other words and according to one embodiment, moisture that may permeate (or enter) into the display unit **120** from the outside is reduced (or blocked) by the getter **140**, which increases (or improves) the lifespan of the display unit **120**.

In particular and according to one embodiment, the getter **140** has been cured from a liquid phase in the form of paste to a solid phase. In one embodiment, the getter **140** is located on the encapsulation layer **130** in a region between the sealant **150** and the display unit **120**.

The filler **160** may be formed between the encapsulation layer **130** and the second substrate **170**. In one embodiment, the filler **160** is configured as a liquid or solid filling layer. The filler **160** may include epoxy, silicon, polyimide, or the like.

In one embodiment, the filler **160** is formed so as to be separated from the getter **140**. The filler **160** is formed between the encapsulation layer **130** and the second substrate **170**, and thus the display unit **120** may be protected from external impact.

In the organic light-emitting display device **1** according to the current embodiment of the present invention, because moisture that may permeate (or enter) into the display unit **120** from the outside is sequentially blocked by the sealant **150** and the getter **140**, a reduced (or a minimum) amount of moisture permeates (or enters) into the display unit **120**, and thus the lifespan of the display unit **120** is increased (or improved), thereby increasing (or improving) the lifespan of the organic light-emitting display device **1**.

In addition, in the organic light-emitting display device **1** according to the current embodiment of the present invention, because the encapsulation layer **130** is formed so as to cover the display unit **120**, impurities that may permeate (or enter) into the display unit **120** may be reduced (or blocked) by the encapsulation layer **130**. Thus, because the lifespan of the display unit **120** is increased (or improved), the lifespan of the organic light-emitting display device **1** is increased (or improved).

FIG. **4** is a schematic plan view illustrating an organic light-emitting display device **2** according to another embodiment of the present invention. FIG. **5** is a schematic cross-sectional view taken along the line V-V shown in FIG. **4**. FIG. **6** is a schematic cross-sectional view taken along the line VI-VI shown in FIG. **4**.

Hereinafter, the current embodiment will be described mainly with regard to differences from the above-described embodiment shown in FIG. **1**.

Referring to FIG. **4**, the organic light-emitting display device **2** according to another embodiment of the present invention may include a first substrate **210**, a display unit **220**, an encapsulation layer **230**, a getter **240**, a sealant **250**, a filler **260**, and a second substrate **270**.

The display unit **220** is located on the first substrate **210**, and the second substrate **270** faces the first substrate **210** with the display unit **220** and the encapsulation layer **230** interposed therebetween. The second substrate **270**, the encapsulation layer **230**, and the first substrate **210** are bonded to each other by the sealant **250** and are sealed. The first substrate **210** and the second substrate **270** protect the display unit **220** from external interference.

The display unit **220** is formed on the first substrate **210** and displays an image.

The encapsulation layer **230** is formed so as to cover the display unit **220** and to protect the display unit **220**. In addition, the encapsulation layer **230** has a concavo-convex region **A** on the outside of the display unit **220**.

The concavo-convex region **A** of the encapsulation layer **230** may be formed using a mask (not shown) having a pattern (e.g., a predetermined pattern) when forming the encapsulation layer **230**. When the concavo-convex region **A** is formed, the getter **240** may contact the encapsulation layer **230** and the first substrate **210**, and the sealant **250** may contact the encapsulation layer **230** and the first substrate **210**. The shape of the concavo-convex region **A** is not limited to that illustrated in FIG. **4**, and as long as the concavo-convex region **A** satisfies the above-described conditions, the concavo-convex region **A** may have any suitable shape.

The sealant **250** is located between the first substrate **210** and the second substrate **270** in the concavo-convex region **A** of the encapsulation layer **230**, surrounds the display unit **220** so as to be spaced apart from the display unit **220** at an interval (e.g., a predetermined interval), and is disposed (or located)

along edges of the encapsulation layer **230** and the second substrate **270**, and thus the first substrate **210** and the second substrate **270** are bonded to each other and sealed.

The getter **240** is located between the display unit **220** and the sealant **250**. The getter **240** may be formed in the concavo-convex region **A** of the encapsulation layer **230**.

Referring to FIG. **5**, the sealant **250** is formed in the concavo-convex region **A** of the encapsulation layer **230**, and thus the sealant **250** contacts both the encapsulation layer **230** and the first substrate **210**. When the sealant **250** is formed in the concavo-convex region **A** of the encapsulation layer **230**, a contact area between the sealant **250** and the encapsulation layer **230** may be enlarged. Thus, in one embodiment the adhesion between the sealant **250** and the encapsulation layer **230** is increased (or enhanced), thereby increasing (or enhancing) the mechanism reliability of the organic light-emitting display device **2**.

In addition, as the contact area between the sealant **250** and the encapsulation layer **230** is enlarged, a width **W** of the sealant **250** may be reduced while the same contact force as that of a case where the concavo-convex region **A** is not formed in the encapsulation layer **230** is maintained. Thus, a non-display region of the organic light-emitting display device **2** is reduced, thereby increasing (or improving) the appearance of the organic light-emitting display device **2**.

Referring to FIG. **6**, the getter **240** is formed in the concavo-convex region **A** of the encapsulation layer **230**, and thus the getter **240** contacts both the encapsulation layer **230** and the first substrate **210**. Thus, moisture permeating (or entering) from the outside passes through the encapsulation layer **230** and the getter **240**. The encapsulation layer **230** delays the permeation (or entrance) of moisture by reducing (or blocking) a passage (e.g., a permeation passage) of the moisture. The getter **240** formed in the concavo-convex region reduces (or prevents) the penetration of the moisture having been delayed and passed. In other words, the passages (e.g., the permeation passages) of the moisture through the encapsulation layer **230** are dispersed, and thus various moisture permeation blocking lines may be provided.

FIGS. **7** and **8** are cross-sectional views illustrating a method of manufacturing the organic light-emitting display device **1** according to the embodiment of the present invention shown in FIG. **1**.

Referring to FIGS. **7** and **8**, after the display unit **120** and the encapsulation layer **130** are formed on the first substrate **110**, the sealant **150** is formed on the encapsulation layer **130** so as to surround the display unit **120** and to be spaced apart from the display unit **120** at an interval (e.g., a predetermined interval). The sealant **150** may be formed of an organic material containing a photo-curing material or an organic/inorganic composite material by using a coating process, a printing process, or the like.

Next, the liquid getter **140** in the form of paste is formed on the encapsulation layer **130** between the sealant **150** and the display unit **120**. The liquid getter **140** may be formed by a coating process, a dripping process, a spraying process, or the like.

Next, after the filler **160** is formed on the second substrate **170**, the first substrate **110** and the encapsulation layer **130** are bonded (or coupled) to each other and sealed.

Hereinafter, the bonding and sealing of the first substrate **110** and the second substrate **170** will be described in more detail.

First, the second substrate **170** at which the filler **160** is formed is disposed (or located) on the first substrate **110** on which the display unit **120** is located with the liquid getter **140**

interposed therebetween. At this time, the second substrate 170 contacts the sealant 150 and the liquid getter 140.

Next, the sealant 150 that is externally exposed is treated with light such as UV rays to cure the sealant 150.

Then, heat is applied to the getter 140 to change its phase from liquid to solid. The solid getter 140 and the solid filler 160 may be separated from each other.

As such, the first substrate 110 (and/or the encapsulation layer 130) and the second substrate 170 are bonded to each other and sealed, thereby completing the manufacture of the organic light-emitting display device 1.

In the above-described process, if the first substrate 110 is formed so as to have a concavo-convex region on the outside of the display unit 120 when forming the display unit 120 and the encapsulation layer 130 on the first substrate 110, the organic light-emitting display device 2 according to another embodiment of the present invention is also manufactured.

According to an aspect of the present invention, external oxygen and moisture that permeates (or enters) into an organic light-emitting element can be effectively reduced (or blocked).

While the present invention has been particularly shown and described with reference to exemplary embodiments thereof, it will be understood by those of ordinary skill in the art that various changes in form and details may be made therein without departing from the spirit and scope of the present invention as defined by the following claims, and equivalents thereof.

What is claimed is:

1. An organic light-emitting display device comprising:
 - a first substrate;
 - a display unit on the first substrate;
 - an encapsulation layer covering the display unit and having a concavo-convex region at the outside of the display unit;
 - a second substrate on the first substrate, wherein the display unit is interposed therebetween;
 - a sealant between the encapsulation layer and the second substrate and at the outside of the display unit, wherein the sealant bonds the encapsulation layer and the second substrate to seal them; and
 - a getter between the sealant and the display unit at the concavo-convex region, wherein the getter contacts each of the first substrate, the second substrate, and the encapsulation layer.
2. The organic light-emitting display device of claim 1, further comprising a filler between the encapsulation layer and the second substrate.
3. The organic light-emitting display device of claim 1, wherein the encapsulation layer comprises at least one

selected from the group consisting of SiNx, SiOx, SiOC, and SiC and combinations thereof.

4. The organic light-emitting display device of claim 1, wherein the sealant comprises a photo-curing material.

5. The organic light-emitting display device of claim 1, wherein the getter is cured from a liquid phase to a solid phase.

6. The organic light-emitting display device of claim 1, wherein the encapsulation layer comprises an inorganic layer.

7. The organic light-emitting display device of claim 1, wherein the second substrate is an opaque substrate, and wherein the display unit is configured to emit light toward the first substrate.

8. A method of manufacturing an organic light-emitting display device, the method comprising:

forming an encapsulation layer on a first substrate at which a display unit is located, so as to cover the display unit;

forming a sealant on the encapsulation layer at the outside of the display unit;

forming a liquid getter in a region between the sealant and the display unit and contacting each of the first substrate, a second substrate, and the encapsulation layer; and

bonding the encapsulation layer and the second substrate together to seal them, wherein the display unit is interposed therebetween,

wherein in the forming of the encapsulation layer on the first substrate, the encapsulation layer has a concavo-convex region at the outside of the display unit.

9. The method of claim 8, wherein the bonding of the encapsulation layer and the second substrate together comprises forming a filler on the second substrate.

10. The method of claim 9, wherein the bonding of the encapsulation layer and the second substrate together comprises:

disposing the second substrate on the encapsulation layer with the liquid getter and the filler interposed therebetween; and

curing the sealant by irradiating it with light.

11. The method of claim 10, wherein the bonding of the encapsulation layer and the second substrate together further comprises applying heat to the liquid getter to change its phase from liquid to solid.

12. The method of claim 11, wherein the solid getter and the filler are separated from each other.

* * * * *

专利名称(译)	有机发光显示装置及其制造方法		
公开(公告)号	US9159953	公开(公告)日	2015-10-13
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[标]申请(专利权)人(译)	三星显示有限公司		
申请(专利权)人(译)	三星DISPLAY CO. , LTD.		
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摘要(译)

一种有机发光显示装置，包括第一基板；第一基板上的显示单元；覆盖显示单元的封装层；第一基板上的第二基板，其中显示单元插入其间；封装层和第二基板之间以及显示单元外部的密封剂，其中密封剂粘合封装层和第二基板以密封它们；密封剂和显示单元之间的区域中的封装层上的吸气剂。

